Fast and reliable storage using a 5 bit, nonvolatile photonic memory cell

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Optically storing and addressing data on photonic chips is of particular interest as such capability would eliminate optoelectronic conversion losses in data centers. It would also enable on-chip non-von Neumann photonic computing by allowing multinary data storage with high fidelity. Here, we demonstrate such an optically addressed, multilevel memory capable of storing up to 34 nonvolatile reliable and repeatable levels (over 5 bits) using the phase change material Ge2Sb2Te5 integrated on a photonic waveguide. Crucially, we demonstrate for the first time, to the best of our knowledge, a technique that allows us to program the device with a single pulse regardless of the previous state of the material, providing an order of magnitude improvement over previous demonstrations in terms of both time and energy consumption. We also investigate the influence of write-and-erase pulse parameters on the single-pulse recrystallization, amorphization, and readout error in our multilevel memory, thus tailoring pulse properties for optimum performance. Our work represents a significant step in the development of photonic memories and their potential for novel integrated photonic applications.

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1. INTRODUCTION

Phase-change materials (PCMs) have recently emerged as a highly promising solution in multilevel cell (MLC) random access memory applications for high-capacity data storage together with other potential MLC materials, such as ferroelectric (FRAM) [1,2], resistive metal oxide (RRAM), and magnetic random access memory (MRAM) materials [3–5]. Among these materials, PCMs are particularly attractive due to their capacity for multilevel, stable, and repeatable memory states with long endurance and good scalability [6–9]. This makes use of the high resistance contrast between the crystalline and amorphous state in PCMs, which enables multilevel operation by controlling the ratio between the two states in a memory cell electrically. Due to the reinforced Peierls distortion upon aging [10], the stochastic nature of crystalline domain formation in PCMs [11,12], and the nonlinear dependence of resistance on the WRITE voltage [13], accurately reaching arbitrary resistance states via a single electrical programming pulse is challenging. A common method currently used to overcome this issue in PCMs is the program-and-verify (P&V) [13–15] iterative method, which involves measuring the resistance of the device during the writing process until the resistance reaches the target value. This method increases the complexity of writing data to electronic PCM-integrated electronic memory (phase-change random access memory, PRAM). Additionally, the resistance states of PRAM devices drift over time due to structural relaxation [16–19]. This adds unwanted complexity in differentiating between neighboring resistance states over time.

On the other hand, PCMs have demonstrated excellent performance in the optical domain and have been successfully commercialized as an optical disk storage medium in the last few decades owing to their high optical contrast and long-term stability [20], albeit for binary data storage. Recent work combining PCMs with photonic circuits brings additional benefits specific to on-chip photonics, such as high bandwidth [21], wavelength division multiplexing [22], and low cross talk [23], compared with the electronic PRAM counterpart. This has not only enabled all-optical data storage on chip, but also allowed limited multilevel storage (eight levels), improved SNR, and reduced switching energy over available optical storage technologies [24–28]. The ability to cascade and address multiple PCM memory cells in this fashion has additionally enabled optical computing in memory by realizing abacus-like arithmetic.
addition, subtraction, and multiplication [26], and matrix-vector multiplication [29].

While integrated photonic devices based on PCMs have been a highly enabling technology, up to now, all these demonstrations have used limited levels (≤10 unique levels) and require multiple pulses to incrementally crystallize larger and larger regions of the memory cell to reach a fully crystalline state [30], which can be a time- and energy-consuming process. In this work, therefore, we develop an innovative single-pulse programming method that is fast, energy-efficient, and, importantly, enables dense, multilevel storage in a photonic device. Specifically, we here demonstrate that it is possible to achieve 34 arbitrary levels, corresponding to over 5 bits, in a single PCM cell with precision and repeatability. This is accomplished using a novel modulation scheme where a single, double-step optical pulse can achieve arbitrary programming operations in less than 250 ns. We further explore the relationship between the pulse shape and the amorphization/recrystallization processes, thereby significantly reducing both the programming time and energy required to operate integrated PCM photonic memory.

2. RESULTS AND MEASUREMENTS

We begin by exploring the multilevel storage capabilities of our photonic PCM memory using a dual-pulse scheme for inducing amorphization (programming) and crystallization (erasing) of the cell. Figure 1(a) shows an optical image of the completed device with a cross section of the photonic memory cell. In Fig. 1(b), we illustrate our method for dual-pulse manipulation of the Ge2Sb2Te5 (GST) transmission state. A programming pulse of 20 ns in width is used to control the fraction of amorphous versus crystalline material, which determines the final transmission state of our device. To return the GST to a fully crystalline state, a fixed ERASE pulse with a trailing rectangular profile is used, regardless of the previous state of the memory cell. Using combined finite element method (FEM) and finite-difference time domain (FDPTD) simulations, we demonstrate the influence of the programming pulse amplitude on the crystalline area of a 2-μm-long strip GST in Fig. 1(c). With the increasing of the pulse power, the transmission increases with the growing of the amorphous region accordingly. Figure 1(d) shows the simulated temperature distribution at the center of the GST immediately after the programming pulse. The area where the temperature surpasses the melting temperature of GST (890 K as measured by Yamada et al. [31]) is shown in dark red and denotes the final amorphous region of the memory cell after a single programming pulse. To simulate the reverse process is much more challenging and requires fully coupled simulations that account for the time-varying optical, thermal, and nucleation dynamics in the device. Therefore, in this article, we will focus on understanding the mechanism of the ERASE pulse through empirical techniques.

A. Dual-Pulse, Multilevel Operation

We first experimentally demonstrate the ability to store 34 unique transmission levels in a single cell of GST as shown in Fig. 2(a). Here, we use a rectangular programming pulse of 50 ns to reach an arbitrary level of higher transmission and another fixed, double-step ERASE pulse (50 ns high amplitude followed by...
200 ns low amplitude) to return to the fully crystalline baseline transmission. Figure 2(a) and subsequent time traces of multilevel operation have been postprocessed with a low-pass filter to reduce the higher frequency noise present in our electronic analog-to-digital converter (see Supplement 1 for experimental setup). Although GST itself has issues related to state changes due to aging over time, which is still under investigation [10], our devices show excellent stability with time. These unique transmission levels shown in Fig. 2(b) are nonvolatile and shown to be stable for many months in integrated photonic systems [25] and over 10 years in optical disk storage devices [20]. To quantify the repeatability of deterministically reaching these levels with a single ERASE/programming pulse, we repeat the same series of pulses (33 programming pulses with increasing amplitude and 33 fixed ERASE pulses) 10 times and plot a histogram of the error between the target transmission and actual transmission [see Fig. 2(c)]. We see that the standard deviation for all levels is below 0.5% from the total change in transmission, which demonstrates the highly repeatable nature of our devices (further discussion in Supplement 1). Despite our efforts to minimize mechanical and thermal drift in our setup, the single-pulse accuracy can be further improved by reducing minor fluctuations in the polarization and pulse power coupled into and out of the grating couplers on our device.

To determine the maximum operation speed of our integrated optical memory, we monitored the transmission of a low power probe while sending a programming and ERASE pulse (this time with 25 ns and 125 ns durations, respectively) and varying the time delay between them. Figure 2(d) shows the resulting time-dependent transmission of the probe for delays ranging from 50 ns to 1 μs. The initial dip in the transmission is due to increased absorption of the probe from free carrier absorption and the thermo-optic effect, which has been extensively studied in previous works [32–34]. While free carrier absorption decays in tens of femtoseconds after the trailing end of the programming pulse, the thermo-optic effect decays over hundreds of nanoseconds as the GST reaches thermal equilibrium with the surrounding waveguide and substrate. This limits the minimum amount of time required for settling before accurately determining the state of the memory cell to approximately 200 ns. A settling time of approximately 500 ns is required for the ERASE pulse. This is a significant improvement over other multilevel memory cells operating at time scales of tens of kHz [15,35–37] since we do not require feedback from multiple programming and verify iterations to reach the desired level. While the minimum duration of the ERASE pulse is ultimately determined by the crystallization rate of the PCM (less than 1 ns for GST [38]), the amorphization/melting process occurs in several picoseconds [39], and therefore, much shorter optical pulses could be used to switch the cell (and indeed have been used [30,40]). This could reduce the 200 ns thermal decay we observe in Fig. 2(d) and is a subject for further investigation.

While other groups have demonstrated using picosecond or femtosecond optical pulses to change the optical property of GST such as absorption [30,39,41], previous demonstrations of GST-based photonic memory using multiple pulses of the same amplitude required large numbers of pulses ranging from several tens to thousands [26,27,29] to return to the fully crystalline state after amorphization. This resulted in typical total ERASE energies and times of approximately 10 nJ and 4 μs, respectively [26]. We improve on this by more than an order of magnitude in both time (250 ns) and energy (680 pJ) with our double-step ERASE pulse. Although dual-pulse programming methods, low drift, and multilevel electrical devices have been demonstrated in separate contexts and different devices in the past [13,42,43], we wish to point out that we combine all these advantages for the first time, to the best of our knowledge. This is enabled by our all-optical platform where we have observed 34 unique, stable, and reliable memory states—certainly a first demonstration, at least in an integrated photonics context.

**B. Controlling Degree of Recrystallization with a Double-Step Programming Pulse**

To better understand the influence of the ERASE pulse shape on the final ratio of amorphous to crystalline material in the memory cell, we varied both the amplitude and duration of the trailing end of the pulse and measured the final transmission state, as illustrated in Fig. 3(a). In the first case, the initial 50 ns portion of the double-step pulse was kept at a fixed amplitude, while the later portion of the pulse varied in amplitude, but maintained a fixed duration of 200 ns. The observed change in transmission is relatively insensitive to low amplitudes of the pulse’s trailing end, becoming much more influential for relative amplitudes larger than 0.2 [see Fig. 3(b)] and reaches full crystallization at a relative amplitude of 0.37. This results in the highly nonlinear response observed in Fig. 3(b) and can be attributed to onset of recrystallization. In other words, if the amplitude of the trailing end of the double-step pulse is below a certain threshold, the temperature of the GST will fall below the crystallization temperature before

![Fig. 3. Measurement of the final transmission state of GST after various double-step programming pulses.](image-url)
recrystallization can occur. Once this temperature threshold is reached, recrystallization occurs, and thus a sharp decrease in the final transmission state is observed.

In a similar manner, controlling the length of the trailing end of the double-step programming pulse controls the length of time over which crystallization is allowed to occur. This is seen in the final state of the transmission [Fig. 3(c)], which initially decreases linearly with increasing programming time until finally saturating at the fully crystalline state for times greater than 150 ns. The distribution of error in the recrystallization process by varying both amplitude and duration of the programming pulse can be seen in the insets of Figs. 3(b) and 3(c).

C. Single-Pulse, Multilevel Operation

We finally demonstrate an improved programming technique that requires only a single pulse to reach any transmission level regardless of the previous state of the device. Instead of fully recrystallizing the GST before moving to a new transmission level [illustrated in Fig. 4(a)], here we use one double-step pulse as demonstrated above, but with varying durations of the second step [illustrated in Fig. 4(b)]. This is made possible by the initial 50 ns portion of the double-step programming pulse with a high amplitude, which erases the previous state and heats the GST above the crystallization temperature. The duration of the second step of the programming pulse determines the time over which the memory cell is allowed to crystallize and programs the final, nonvolatile transmission state of GST. An experimental demonstration of this can be seen in Fig. 4(c), which shows how the memory cell can be switched from high-to-low and low-to-high transmission states regardless of the previous material configuration. Again, we show the accumulated transmission statistics of 20 unique transmission levels after sending 200 programming pulses with randomly assigned step widths [see Fig. 4(d)]. The standard distribution of the error shown in the inset of Fig. 4(c) is 0.482%.

3. CONCLUSION

In summary, we have shown the first demonstration, to the best of our knowledge, of 5 bit programming in a single integrated photonic memory cell. This was achieved using a technique that can realize full recrystallization of an integrated photonic PCM memory cell regardless of the state of the material. This was made possible by pulse shaping to precisely control the time-dependent temperature profile in the GST layer. To elucidate the mechanism behind this technique, we performed a parameter sweep of the double-step programming pulse in both amplitude and duration of second step and observed the degree of recrystallization. This understanding enabled us to design a flexible single-pulse programming technique, which allows for high-speed programming of the memory cell regardless of the previous state of the PCM. The 34 levels created in a single memory cell demonstrated the lowest drift seen in such devices. Our results are a broad and fundamental step towards a fast, low-power on-chip photonic memory for applications such as neuromorphic computing [24] and in-memory computing [29] on a photonic platform.

APPENDIX A: METHODS

1. Device Fabrication

Our device consists of a Ge2Te2Sb2 thin film passivated with a layer of indium-tin-oxide (ITO) and evanescently coupled to a Si3N4 photonic waveguide. Electron beam lithography and dry etching were used to define shallow-etched Si3N4 waveguides. Islands of GST were fabricated with a lift-off process involving an aligned write electron beam lithography step followed by RF sputtering of 10 nm GST and 10 nm ITO (30 W RF power, 1.1 mTorr Ar atmosphere, and 2 × 10⁻⁷ Torr base pressure). In order to enhance the interaction with the optical mode, a post-sputter annealing step (250°C for 10 min) was used to fully crystallize the GST.

2. Measurement Setup

We use a 1590 nm laser source, amplified with an L-band erbium-doped fiber amplifier (EDFA) to optically switch the state of the GST and a 1610 nm continuous probe laser to monitor the transmission of light. To shape the optical pulses, an arbitrary function generator (Tektronics 100 MHz AFG3102C) is used to send RF pulses to a high-speed electro-optic modulator (EOM). The nonlinear response of the EOM is compensated by the shape of the input RF pulse such that the pulse shape we describe above reflects the shape of the optical pulse after the EDFA rather than the input electrical pulse. Optical bandpass filters are used in both beam paths to reduce the influence of parasitic wavelengths. At the end of both paths, we use low-noise-sensitive photodetectors to record the dynamic change of the transmission of the light and a fast-speed sampling oscilloscope to record the thermo-optical effect of the device when it is excited by writing pulses. With this measurement scheme, we are able to observe phase transitions in real-time with subnanosecond resolution.
In order to control the power of the pulses sent to the device, we use a tunable optical attenuator to control the power of the pump seed laser before the EOM. In this way, we can provide more control over the amplitude and repeatability of the pulse power and achieve the 34 levels shown in Fig. 2. In order to reduce the fluctuation of the polarization of the probe seed laser, we also added an in-line fiber polarizer, a polarization controller, and reference photodiode between the probe laser and device to remove the noise from polarization drift due to thermal fluctuations in the setup.

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